

20W Stereo Digital Class-D Audio Power Amplifier

Features

- **Operating Voltage: 8.0V~24V for PVDD**
– 3.0V~3.6V for DVDD and AVDD
- **High Efficiency Class-D Operation Eliminate the Need of Heatsinks**
- **Digital Serial Audio Input (Stereo Output)**
- **I²C Control Interface**
- **Sampling Rate can Support from 32kHz to 192kHz**
- **Separated Volume Control from 24dB to Mute**
- **Soft Mute (50% Duty Cycle)**
- **Shutdown and Mute Function**
- **Thermal and Over-Current Protections with Auto-Recovery**
- **Space Saving Package TQFP7x7-48P**
- **Lead Free and Green Devices Available (RoHS Compliant)**

General Description

The APA3160A is a digital input, stereo, high efficiency, Class-D audio amplifier available in a TQFP7x7-48P package.

The APA3160A accepts the digital serial audio data and using the digital audio processor to convert the audio data becomes the stereo Class-D output speaker amplifier. This provides the seamless integration between the codec and the speaker amplifier.

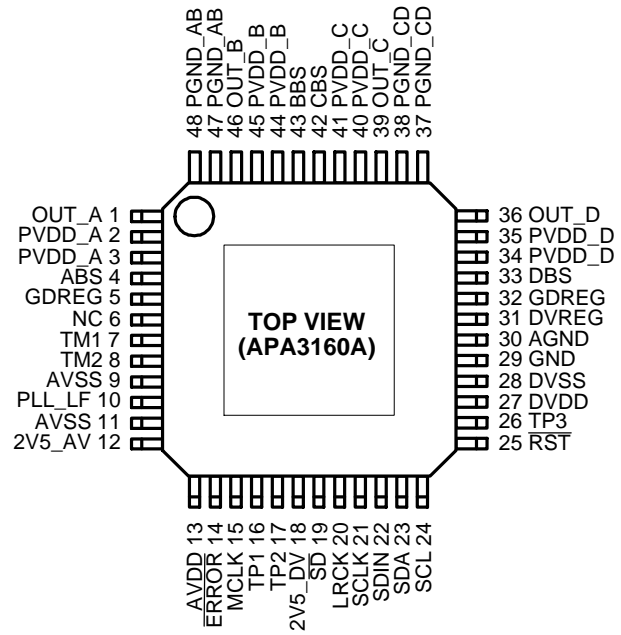
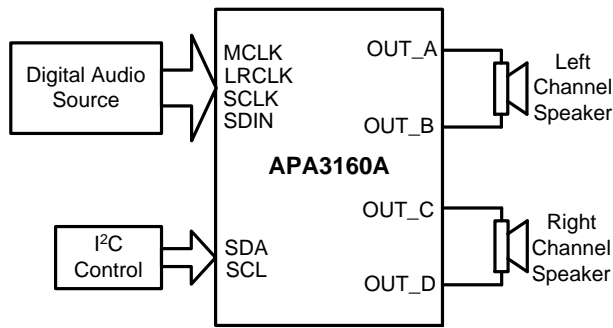
The APA3160A is a slave device receiving clocks from external source, and the Class-D's PWM switching frequency is 352.8kHz for the sampling rate 44.1kHz or 384 kHz for sampling 48kHz, depend on the input signal's sampling rate.

Pin Configuration

Applications


- LCD TV

Simplified Application Circuit



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Ordering and Marking Information

<p>APA3160A □□□□-□□□</p> <div style="margin-left: 40px;"> <p>└─ Assembly Material</p> <p>└─ Handling Code</p> <p>└─ Temperature Range</p> <p>└─ Package Code</p> </div>	<p>Package Code QCA : TQFP7x7-48P</p> <p>Operating Ambient Temperature Range I : -40 to 85 °C</p> <p>Handling Code TR : Tape & Reel</p> <p>Assembly Material G : Halogen and Lead Free Device</p>
<p>APA3160A QCA :</p> <div style="border: 1px solid black; padding: 2px; display: inline-block; text-align: center;">  APA3160A XXXXX </div>	<p>XXXXX - Date Code</p>

Note : ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rating	Unit
	Supply Voltage (PVDD_X to PGND_XX)	-0.3 to 26	V
	Supply Voltage (DVDD to DVSS)	-0.3 to 3.6	
	Supply Voltage (AVDD to AVSS)	-0.3 to 3.6	
	Input Voltage (MCLK to AVSS)	-0.5 to AVDD+2.5	
	Input Voltage (\overline{SD} , \overline{RST} , LRCLK, SCLK, SDIN, SDA, SCL to DVSS)	-0.5 to DVDD+2.5	
	Input Voltage (OUT_X to PGND_XX)	-0.3 to +32	
	Input Voltage (XBS to PGND_XX)	-0.3 to +43	
	Input Voltage (AVSS, DVSS, AGND to PGND_XX)	-0.3 to +0.3	
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _{SDR}	Soldering Temperature Range, 10 seconds	260	°C
P _D	Power Dissipation	Internally Limited	W

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Thermal Characteristics

Symbol	Parameter	Typical Value	Unit
θ_{JA}	Junction-to-Ambient Resistance in Free Air ^(Note 2) TQFP7x7-48P	25	°C/W
θ_{JC}	Junction-to-Case Resistance in Free Air ^(Note 3) TQFP7x7-48P	-	°C/W

Note 2: θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. The exposed pad of TQFP7X7-48P is soldered directly on the PCB.

Note 3: The case temperature is measured at the center of the exposed pad on the underside of the TQFP7X7-48P package.

Recommended Operating Conditions

Symbol	Parameter	Range		Unit	
		Min.	Max.		
V _{DD}	Supply Voltage	3	3.6	V	
PV _{DD}	Full Bridge Stage Supply Voltage (PVDD_X)	8	24		
V _{IH}	High Level Threshold Voltage	SD, MCLK, LRCLK, SCLK, SDIN, SDA, SCL, RST	2		5
V _{IL}	Low Level Threshold Voltage	SD, MCLK, LRCLK, SCLK, SDIN, SDA, SCL, RST	0		1
T _A	Ambient Temperature Range	-40	85	°C	
T _J	Junction Temperature Range	-40	125		
R _L	Speaker Resistance	6	-	Ω	
L _O	Output Low Pass Filter Inductance	10	-	μH	

PWM Operating Conditions

Symbol	Parameter	Test Conditions	Value	Unit
f _s	Output Sample Rate	32 kHz Data Rate ±2%	256	kHz
		44.1k/88.2k/176.4 kHz Data Rate ±2%	352.8	
		48k/96k/192 kHz Data Rate ±2%	384	

PLL Input Parameters and External Filter Components

Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
f _{MCLK}	MCLK Frequency		2.8224	-	24.576	MHz
	MCLK Duty Cycle		40	50	60	%
tr/tf (MCLK)	Rise/Fall Time for MCLK		-	-	5	ns
	LRCLK Allowable Drift before LRCLK Reset		-	-	4	MCLKs
	External PLL Filter Capacitor C1	SMD 0603 Y5V	-	47	-	nF
	External PLL Filter Capacitor C2	SMD 0603 Y5V	-	4.7	-	
	External PLL Filter Resistor R		-	470	-	Ω

Electrical Characteristics

T_A=25°C, PV_{DD}=18V, V_{DD}=3.3V (AVDD and DVDD), R_L=8Ω, BD Mode, f_s=48kHz (unless otherwise noted)

Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
DC CHARACTERISTICS						
I _{DD}	3.3V Supply Current (AVDD, DVDD)	Normal Mode (No load)	-	10	20	mA
		Reset (No load)	-	7.2	14.5	
I _{PVDD}	Full Bridge Stage Supply Current (PVDD_X)	Normal Mode (No load)	-	18	36	
		Reset (No load)	-	0.5	1	
I _{IL}	Low Level Input Current	V _I <V _{IL} , V _{DD} =3.6V (AVDD and DVDD)	-	150	-	μA

Electrical Characteristics (Cont.)

T_A=25°C, PV_{DD}=18V, V_{DD}=3.3V (AVDD and DVDD), R_L=8Ω, BD Mode, f_s=48kHz (unless otherwise noted)

Symbol	Parameter	Test Conditions	APA3160A			Unit	
			Min.	Typ.	Max.		
DC CHARACTERISTICS (CONT.)							
I _{IH}	High Level Input Current	V _I >V _{IH} , V _{DD} =3.6V (AVDD and DVDD)	-	150	-	μA	
T _{TP}	Thermal Protection Threshold		-	160	170	°C	
	Thermal Protection Threshold Hysteresis		-	25	-		
η	Efficiency	Stereo, R _L =8Ω, P _O =18W	-	88	-	%	
R _{OUT}	Internal Pull-Down Resistance at Each OUT_X		-	3	-	kΩ	
AC CHARACTERISTICS							
P _O	Output Power	THD+N=1% f _{in} =1kHz, R _L =8Ω	PV _{DD} =18V	14.5	16	-	W
			PV _{DD} =12V	6.5	7.2	-	
			PV _{DD} =8V	2.9	3.2	-	
		THD+N=10% f _{in} =1kHz, R _L =8Ω	PV _{DD} =18V	-	20	-	
			PV _{DD} =12V	-	9	-	
			PV _{DD} =8V	-	4	-	
THD+N	Total Harmonic Distortion Plus Noise	f _{in} =1kHz, R _L =8Ω	PV _{DD} =18V, P _O =1W	-	0.06	-	%
			PV _{DD} =12V, P _O =1W	-	0.13	-	
			PV _{DD} =8V, P _O =1W	-	0.2	-	
Crosstalk	Channel Separation	P _O =1W, R _L =8Ω, f _{in} =1kHz	-	-82	-	dB	
Att _{Mute}	Mute Attenuation	f _{in} =1kHz, R _L =8Ω, V _O =1V _{rms}	-	-70	-		
Att _{shutdown}	Shutdown Attenuation	f _{in} =1kHz, R _L =8Ω, V _O =1V _{rms}	-	-110	-		
S/N	Signal to Noise Ratio	R _L =8Ω, P _O =16W, With A-Weighting Filter (A _V =0dB)	-	100	-		
V _n	Noise Output Voltage	With A-Weighting Filter (A _V =0dB)	-	100	200	μV _{rms}	

Serial Audio Ports Slave Mode

Over recommended operating conditions (unless otherwise noted)

Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
f _{SCLK}	Frequency, SCLK 32xf _s , 48xf _s , 64xf _s	C _L =30pF	1.024	-	12.288	MHz
t _{Setup1}	Setup Time, LRCLK to SCLK Rising Edge		10	-	-	ns
t _{Hold1}	Hold Time, LRCLK to SCLK Rising Edge		10	-	-	

Serial Audio Ports Slave Mode (Cont.)

Over recommended operating conditions (unless otherwise noted)

Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
t_{Setup2}	Setup Time, SDIN to SCLK Rising Edge		10	-	-	ns
t_{Hold}	Hold Time, SDIN to SCLK Rising Edge		10	-	-	
	LRCLK Frequency		32K	48K	192K	kHz
	LRCLK Duty Cycle		40	50	60	%
	SCLK Duty Cycle		40	50	60	
	SCLK Rising Edges Between LRCLK Rising Edges		32	-	64	SCLK edges
$t_{(edge)}$	LRCLK Clock Edge With Respect To The Falling Edge of SCLK		-1/4	-	1/4	SCLK period
t_r/t_f (SCLK/LRCLK)	Rise/Fall Time for SCLK/LRCLK		-	-	8	ns

Reset Timing

Control signal parameters over recommended operating conditions (unless otherwise noted). Please refer to “Recommended Use Model” section on usage of all terminals.

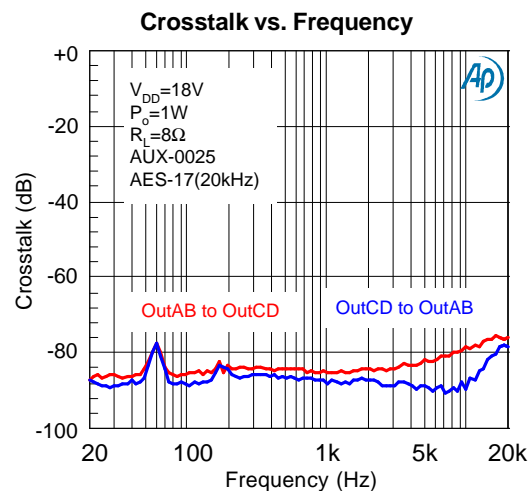
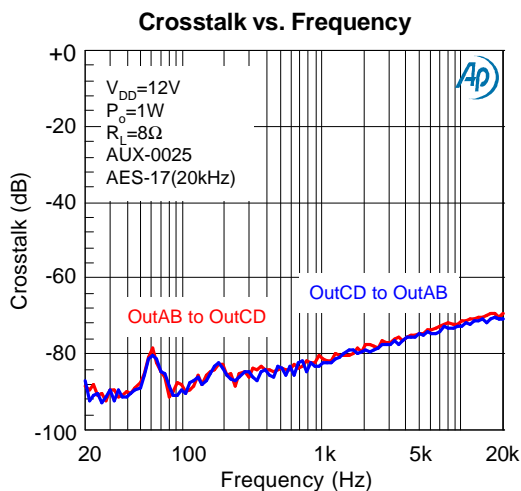
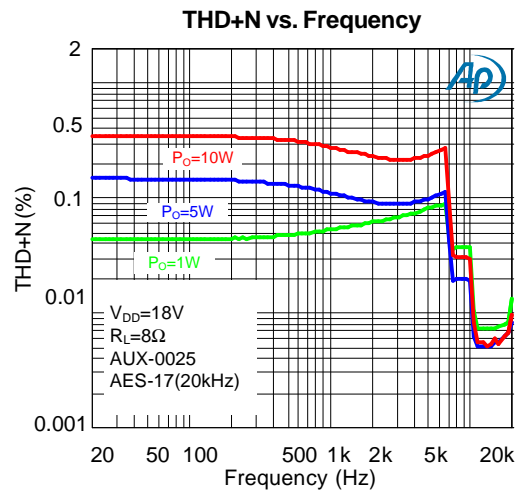
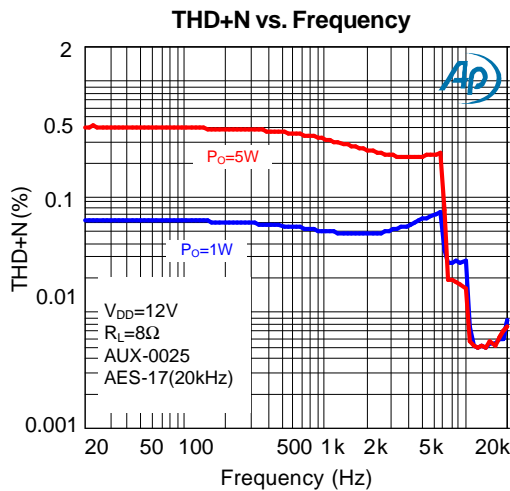
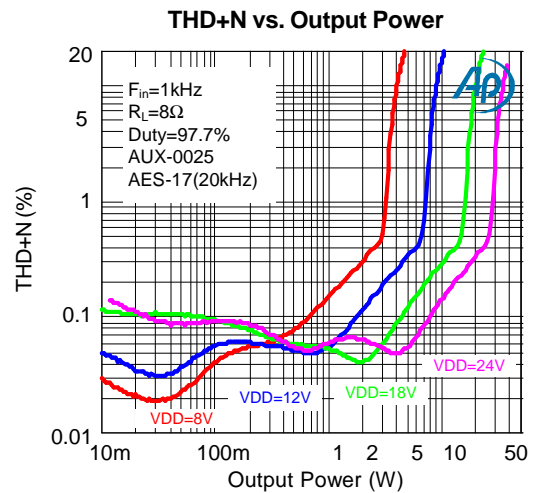
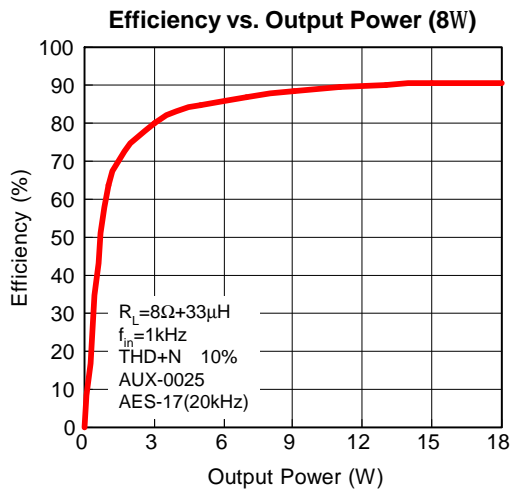
Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
$t_p(\overline{RST})$	Pulse Duration, \overline{RST} Active.	No Load	100	-	-	μ s
$t_d(12C_Ready)$	Time to Enable I ² C		-	-	13.5	ms

I²C Serial Control Port Operation

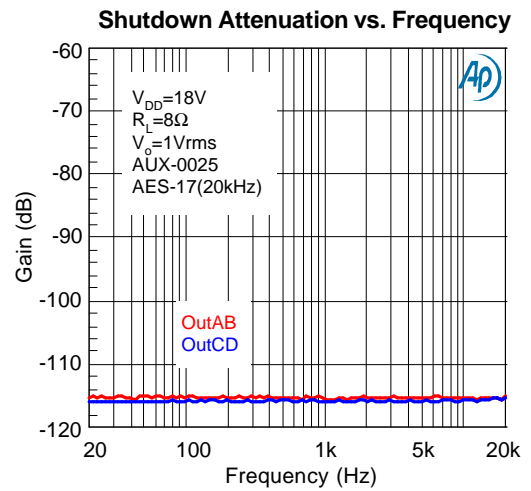
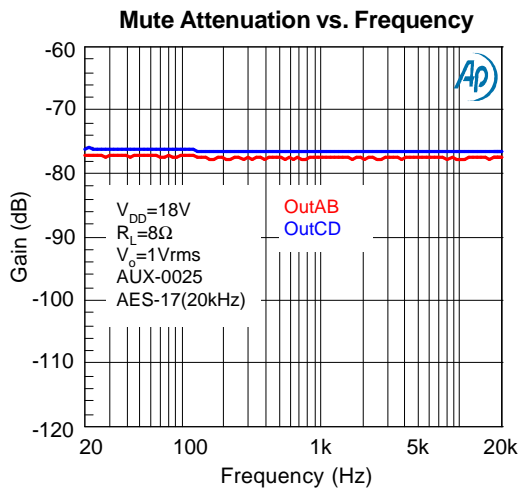
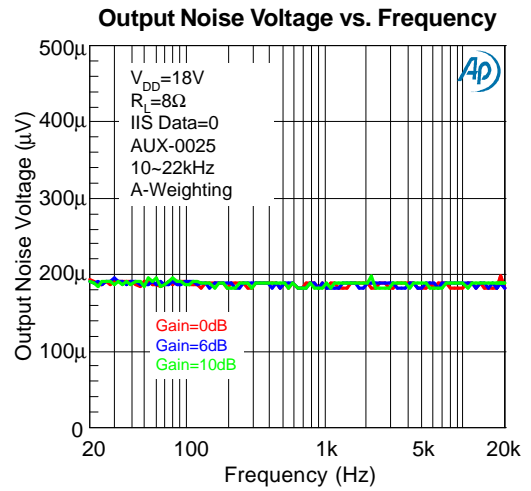
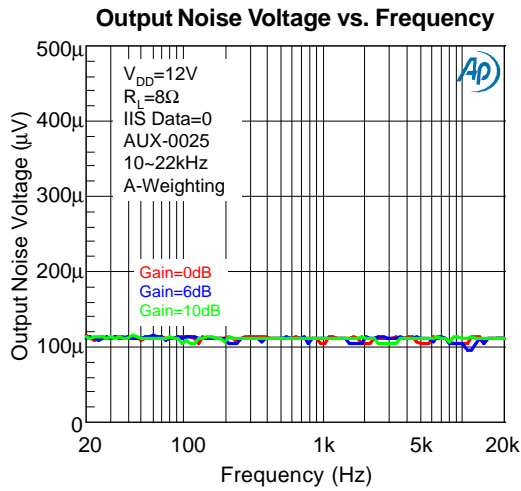
Timing characteristics for I²C Interface signals over recommended operating conditions (unless otherwise noted).

Symbol	Parameter	Test Conditions	APA3160A			Unit
			Min.	Typ.	Max.	
f_{SCL}	Frequency, SCL	No Wait States	-	-	400	kHz
$t_{W(H)}$	Pulse Duration, SCL High		0.6	-	-	μ s
$t_{W(L)}$	Pulse Duration, SCL Low		1.3	-	-	
t_r	Rise Time, SCL and SDA		-	-	300	ns
t_f	Fall Time, SCL and SDA		-	-	300	
t_{setup1}	Setup Time, SCL to SDA		100	-	-	
t_{hold1}	Hold Time, SCL to SDA		0	-	-	μ s
$t_{(buf)}$	Bus Free Time Between Stop and Start Condition		1.3	-	-	
t_{setup2}	Setup Time, SCL to Start Condition		0.6	-	-	
t_{hold2}	Hold Time, Start condition to SCL		0.6	-	-	
t_{setup3}	Setup Time, SCL to Stop Condition		0.6	-	-	
C_L	Load Capacitance for Each Bus Line		-	-	400	pF

Typical Operating Characteristics



Typical Operating Characteristics (Cont.)



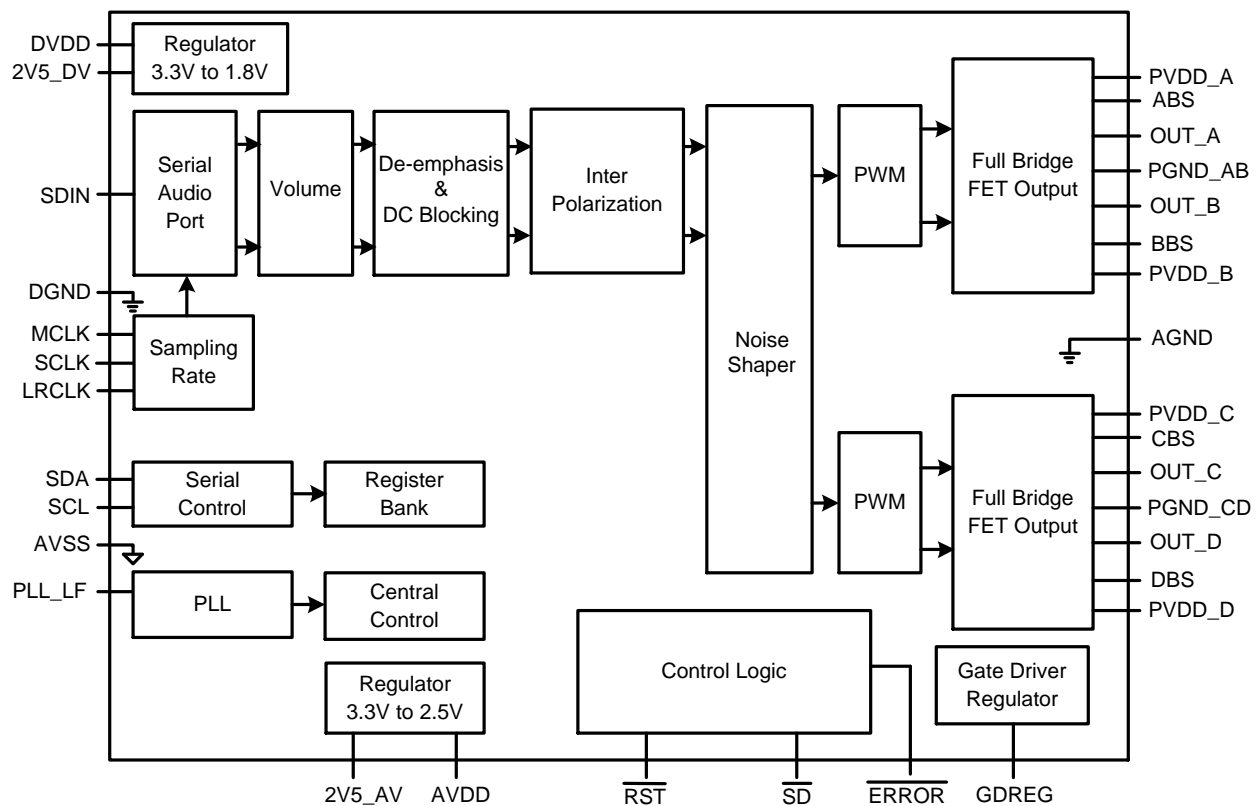
Pin Description

PIN		I/O/P	FUNCTION
NO.	NAME		
1	OUT_A	O	Output of half bridge A.
2, 3	PVDD_A	P	Power supply for half bridge A.
4	ABS	I/O	High side bootstrap supply for half bridge A.
5, 32	GDREG	O/P	Internal regulator output of gate driver.
6	NC	-	No connection.
7	TM1	I	Test mode digital input pin.
8	TM2	I	Test mode digital input pin.
9, 11	AVSS	P	Analog power supply's ground.
10	PLL_LF	O	PLL negative loop filter pin.
12	2V5_AV	O/P	Internal regulated 2.5V for analog block's supply, Not for power external device.
13	AVDD	P	Analog powers supply and connects to 3.3V.
14	$\overline{\text{ERROR}}$	O	When over-temperature, over current over-voltage and under-voltage occur, this pin will be pull low; and it will be reset to high when the fault condition has be remove.
15	MCLK	I	Master clock input.
16	TP1	I/O	Test mode digital input/output pin.
17	TP2	I/O	Test mode digital input/output pin.
18	2V5_DV	O/P	Internal regulated 2.5V for digital block's supply, Not for power external device.
19	$\overline{\text{SD}}$	I	Active LOW, Shutting down the noise shaper and initiating PWM stop sequence.
20	LRCLK	I	Input serial audio data left/right clock. (Sample rate clock), it's weak pull down terminal.
21	SCLK	I	Serial audio data clock (shift clock). SCLK is the serial audio port input data bit clock.
22	SDIN	I	Serial audio data input.
23	SDA	IO	I ² C serial control data interface input/output.
24	SCL	I	I ² C serial control clock input.
25	$\overline{\text{RST}}$	I	Reset control, place a logic low to this pin, will reset the APA3160A to its default condition. It's weak pull-up terminal.
26	TP3	I/O	Test mode digital input/output pin.
27	DVDD	P	Digital powers supply and connects to 3.3V.
28	DVSS	P	Digital power supply's ground.
29	GND	P	Power stage's analog ground.
30	AGND	P	Power stage's analog ground.
31	DVREG	O/P	Digital voltage regulator's output, only for internal used.
33	DBS	I/O	High side bootstrap supply for half bridge D.
34, 35	PVDD_D	P	Power supply for half bridge D.
36	OUT_D	O	Output of half bridge D.
37, 38	PGND_CD	P	Power Ground connection for half bridge C and D.
39	OUT_C	O	Output of half bridge C.
40, 41	PVDD_C	P	Power supply for half bridge C.
42	CBS	I/O	High side bootstrap supply for half bridge C.
43	BBS	I/O	High side bootstrap supply for half bridge B.

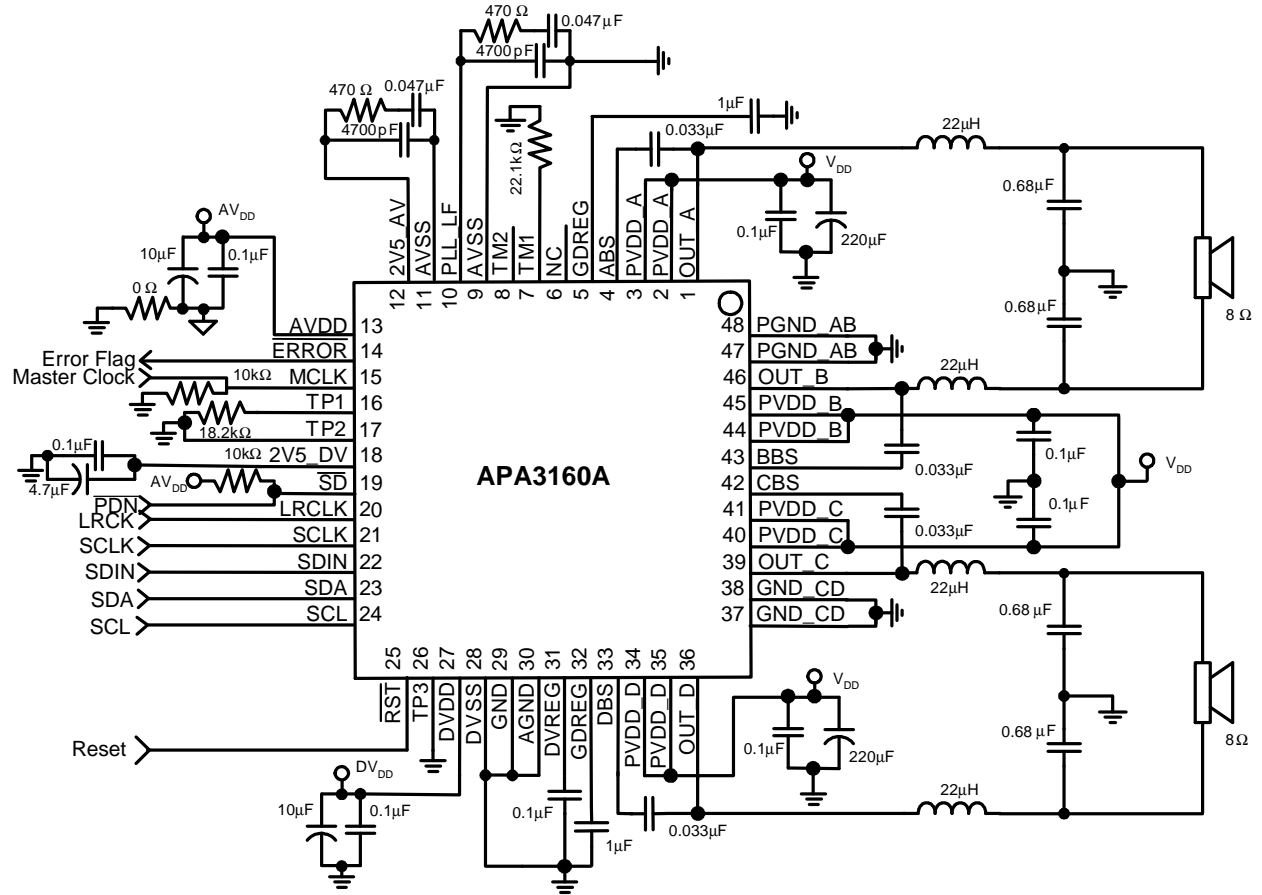
Pin Description (Cont.)

PIN		I/O/P	FUNCTION
NO.	NAME		
44, 45	PVDD_B	P	Power supply for half bridge B.
46	OUT_B	O	Output of half bridge B.
47, 48	PGND_AB	P	Power Ground connection for half bridge A and B.

Block Diagram



Typical Application Circuit



Function Description

Clock And PLL

The APA3160A is a slave device and receives signals from MCLK, SCLK, and LRCLK. The digital audio processor (DAP) provides all sample rates and MCLK rates which defined in the clock control register.

The APA3160A checks to verify that SCLK is a particular value of $32f_s$, $48f_s$, or $64f_s$. The DAP only provides a $1 \times f_s$ LRCLK. The timing relationship of these clocks to SDIN is shown in subsequent sections.

Serial Data Interface

Serial data is an input transmitted to SDIN. The PWM outputs are derived from SDIN. Besides, the APA3160A DAP receives left-justified, right-justified, and I²S serial data formats with 16, 20, or 24 bit.

PWM Section

The APA3160A DAP device is a high power efficiency and high-performance digital audio reproduction. A noise shaper is used to increase dynamic range and SNR in the audio band. The PWM section receives 24bit PCM data from the DAP and outputs two BTL PWM audio output channels.

The PWM section has individual channel dc blocking filters that can be enabled and disabled. The low pass filter cutoff frequency is less than 1Hz. Besides, the PWM section includes individual channel de-emphasis filters for 44.1 and 48 kHz and can be enabled and disabled.

The adjustable maximum modulation limit of PWM section is from 93.8% to 98.4%.

I²C Compatible Serial Control Interface

The APA3160A DAP receives commands from a system controller through an I²C serial control slave interface. The serial control interface supports both normal-speed 100kHz and high-speed 400kHz operations without waiting states. As an added feature, even though the MCLK is absent, the interface operates.

For status registers, the serial control interface provides single-byte read and write operations; and for the general control registers, they associated with the PWM.

Function Description (Cont.)

Serial Interface Control And Timing

I²S Timing

I²S timing uses LRCLK to define the data for the left channel and the right channel when the data being transmitted. For the left channel, the LRCLK is low; for the right channel, the LRCLK is high. A bit clock running at $32, 48, \text{ or } 64 \times f_s$ is used to clock in the data. When the LRCLK signal changes state, there is a delay of one bit clock from the time which the first bit of data on the data lines. The data is written MSB first and is valid on the rising edge of bit clock. The DAP masks unused trailing data bit positions.

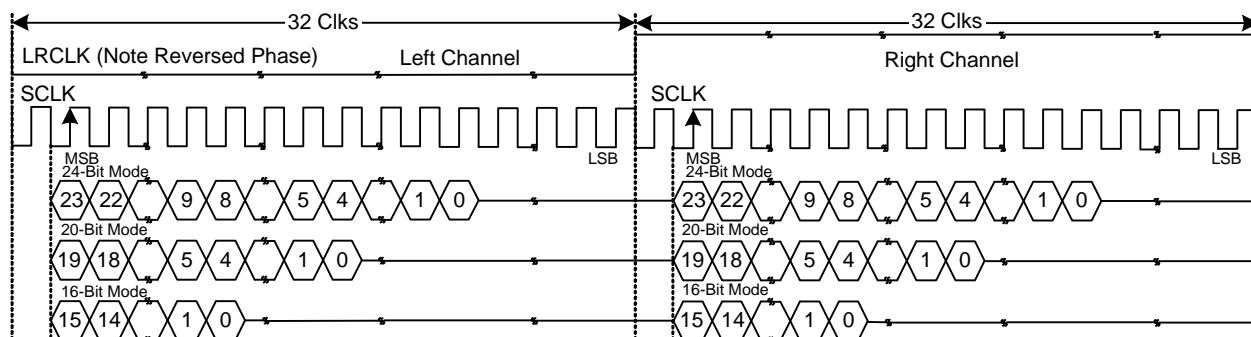


Figure 1. I²S 64 f_s Format

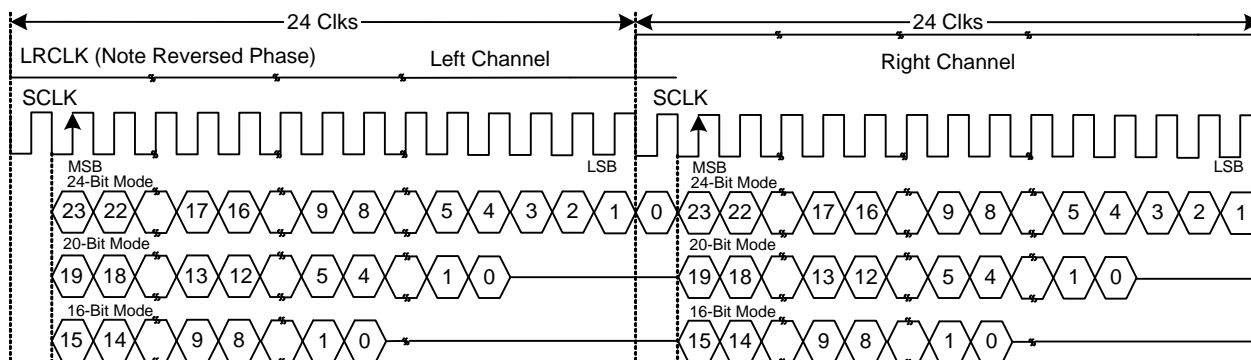


Figure 2. I²S 48 f_s Format

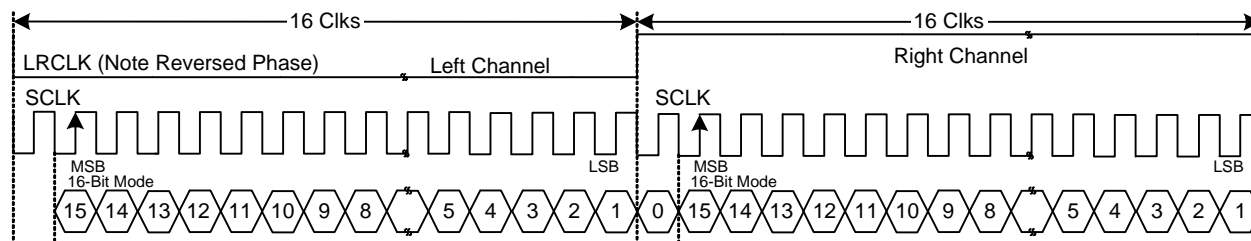


Figure 3. I²S 32 f_s Format

Function Description (Cont.)

Left-Justified

Left-justified (LJ) timing uses LRCLK to define the data for the left channel and the right channel when the data being transmitted. For the left channel, the LRCLK is high; for the right channel, the LRCLK is low. A bit clock running at $32, 48, \text{ or } 64 \times f_s$ is used to clock in the data. The first bit of data appears on the data lines when LRCLK toggles. The data is written MSB first and is valid on the rising edge of the bit clock. The DAP masks unused trailing data bit positions.

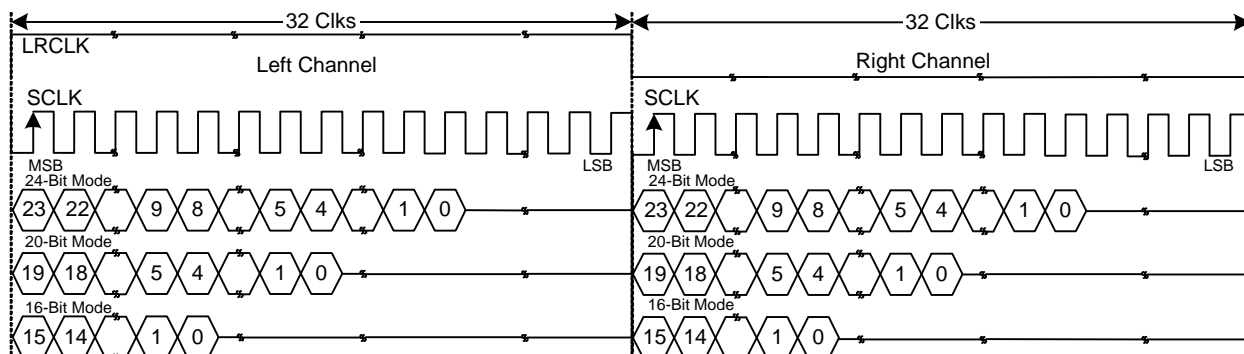


Figure 4. Left-Justified $64 f_s$ Format

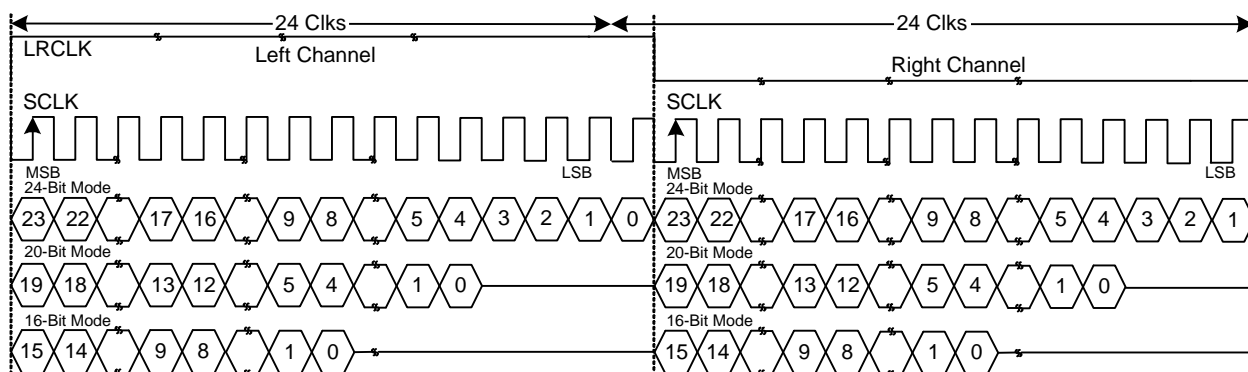


Figure 5. Left-Justified $48 f_s$ Format

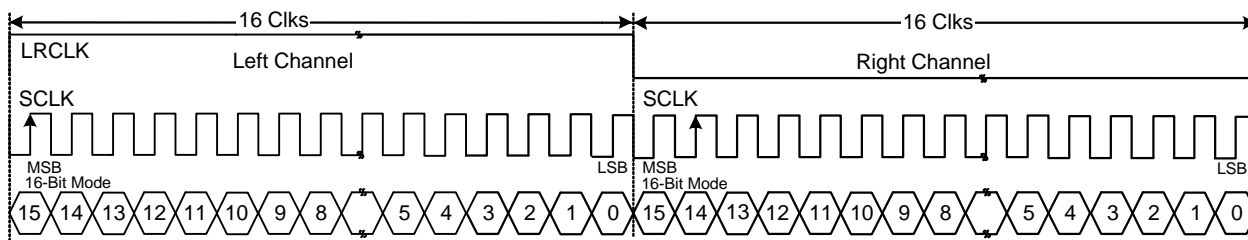


Figure 6. Left-Justified $32 f_s$ Format

Function Description (Cont.)

Right-Justified

Right-justified (RJ) timing uses LRCLK to define the data for the left channel and the right channel when the data being transmitted. For the left channel, the LRCLK is high; for the right channel, the LRCLK low. A bit clock running at $32, 48, \text{ or } 64 \times f_s$ is used to clock in the data. After LRCLK toggles, for 24bit data, the first bit of data appears on the data 8 bit-clock. In RJ mode, the LSB of data is always clocked by the last bit clock before LRCLK transitions. The data is written MSB first and is valid on the rising edge of bit clock. The DAP masks unused leading data bit positions.

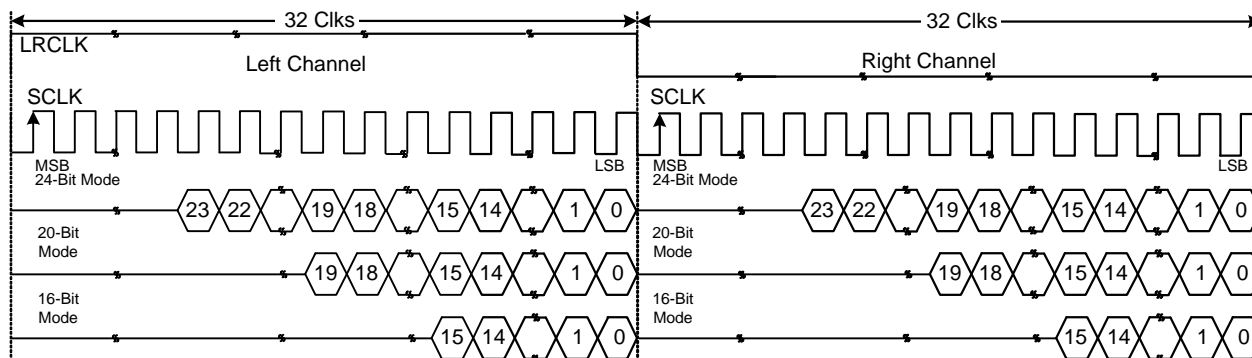


Figure 7. Right-Justified 64 f_s Format

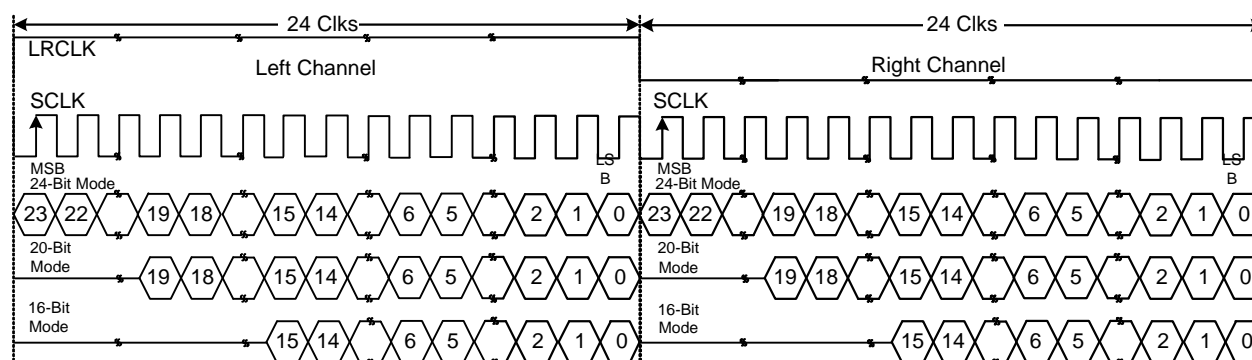


Figure 8. Right-Justified 48 f_s Format

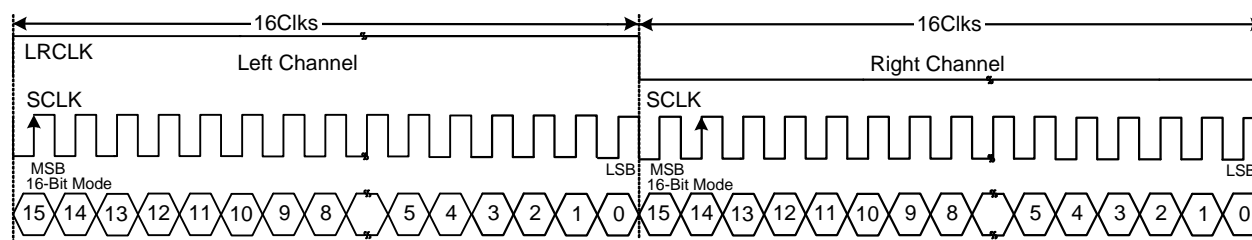


Figure 9. Right-Justified 32 f_s Format

Function Description (Cont.)

I²C Serial Control Interface

The APA3160A DAP has a bidirectional I²C interface that compatible with the I²C (Inter IC) bus protocol. Besides, it provides both 100kHz and 400kHz data transfer rates to single and multiple bytes write and read operations.

This is a slave only device, and it doesn't support a multi-master bus environment or wait state insertion. The function of the control interface is to read device status and to program the registers of the device.

The DAP supports the standard-mode I²C bus operation (100kHz maximum) and the fast I²C bus operation (400kHz maximum). Without I²C wait cycles, the DAP performs I²C operations.

General I²C Operation

The I²C bus uses SDA (data) and SCL (clock) to communicate between integrated circuits in a system. Data is transferred on the bus serially one bit at a time. With the most significant bit (MSB) transferred first, the address and data can be transferred in byte (8bit) format. In addition, each byte transferred on the bus is acknowledged by the receiving device with an acknowledge bit. Each transfer operation begins with the master device driving a start condition on the bus and ends with the master device driving a stop condition on the bus.

The bus uses transitions on the SDA when the clock is high to indicate start and stop conditions. A high-to-low transition on SDA indicates a start, and a low-to-high transition indicates a stop. Normal data bit transitions must occur within the low time of the clock. These conditions are shown in Figure 10. The master generates the 7bit slave address and the read/write (R/W) bit to open communication with another device and then waits for an acknowledge condition. The APA3160A holds SDA low during the acknowledge clock to indicate an acknowledgment. When this occurs, the master transmits the next byte of the sequence.

Each device is addressed by a unique 7bit slave address plus R/W bit (1 byte). All compatible devices share the same signals via a bidirectional bus using a wired-AND connection. An external pull-up resistor must be used for the SDA and SCL signals to set the high level for the bus.

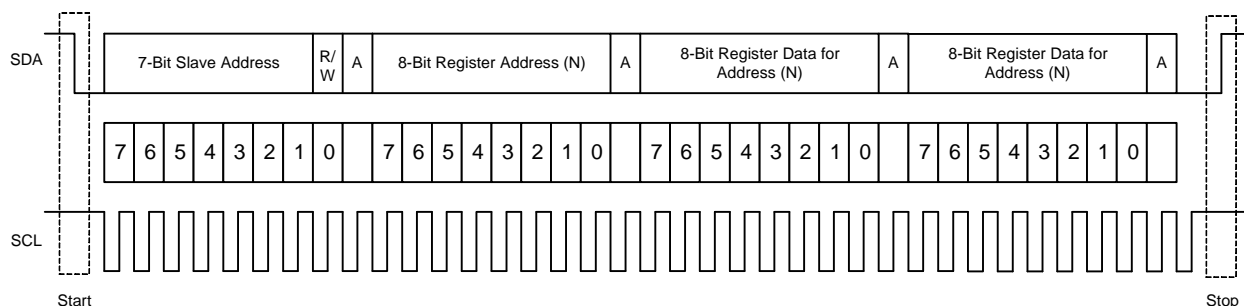


Figure 10. Typical I²C Sequence

There is no limit on the number of bytes that can be transmitted between start and stop conditions. When the last word transfers, the master generates a stop condition to release the bus. A generic data transfer sequence is shown in Figure 10.

The 7bit address for APA3160A is 0011 010 (0x34). APA3160A address can be changed from 0x34 to 0x38 by writing 0x38 to device address register 0xF9.

Function Description (Cont.)

Single-Byte Transfers

The serial control interface supports single-byte and multiple-byte (R/W) operations for sub-addresses 0x00 to 0xFF. Supplying a sub-address for each sub-address transaction is referred to as random I²C addressing. The APA3160A also supports sequential I²C addressing. For write transactions, if a sub-address is issued and followed by data for that sub-address and the 15 sub-addresses that follow, a sequential I²C write transaction has taken place, and the data for all 16 sub-addresses is successfully received by the APA3160A. For I²C sequential write transactions, the sub-address then serves as the start address, and the amount of data subsequently transmitted, before a stop or start is transmitted, determines how many sub-addresses are written. As was true for random addressing, sequential addressing requires that a complete set of data be transmitted. If only a partial set of data is written to the last sub-address, the data for the last sub-address is discarded. However, if all other data written is accepted, only the incomplete data is discarded.

Single-Byte Write

As shown in Figure 11, a single-byte data write transfer begins with the master device transmitting a start condition followed by the I²C device address and the R/W bit. The R/W bit determines the direction of the data transfer. For a write data transfer, the R/W bit will be a 0. After receiving the correct I²C device address and the R/W bit, the DAP responds with an acknowledge bit. And then, the master transmits the address byte or bytes corresponding to the APA3160A internal memory address being accessed. After receiving the address byte, the APA3160A responds with an acknowledge bit again. Next, the master device transmits the data byte to be written to the memory address being accessed. After receiving the data byte, the APA3160A responds again with an acknowledge bit. Finally, the master device transmits a stop condition to complete the single-byte data write transfer.

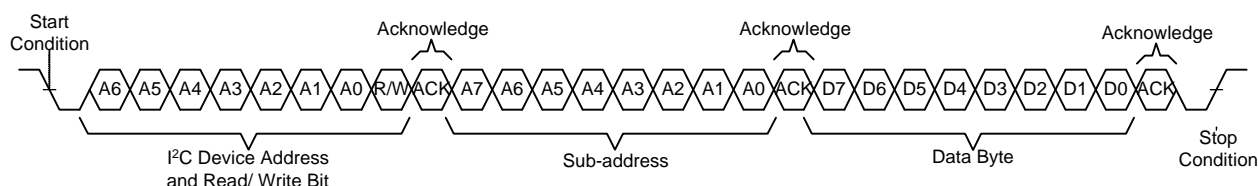


Figure 11. Single-Byte Write Transfer

Function Description (Cont.)

Single-Byte Read

As shown in Figure 12, a single-byte data read transfer begins with the master device transmitting a start condition followed by the I²C device address and the R/W bit. For the data read transfer, both a write followed by a read are actually done. Initially, a write is done to transfer the address byte or bytes of the internal memory address to be read. As a result, the R/W bit becomes a 0. After receiving the APA3160A address and the read/write bit, APA3160A responds with an acknowledge bit. Besides, after sending the internal memory address byte or bytes, the master device transmits another start condition followed by the APA3160A address and the read/write bit again. This time the read/write bit becomes a 1, indicating a read transfer. After receiving the address and the read/write bit, the APA3160A again responds with an acknowledge bit. And then, the APA3160A transmits the data byte from the memory address being read. After receiving the data byte, the master device transmits a not acknowledge followed by a stop condition to complete the single byte data read transfer.

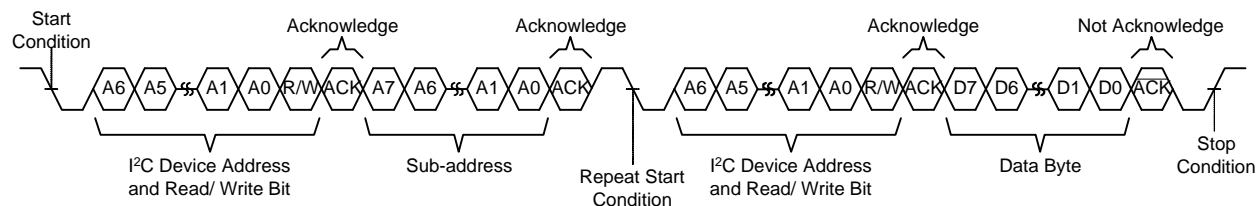


Figure 12. Single-Byte Read Transfer

Function Description (Cont.)

Recommended Use Model

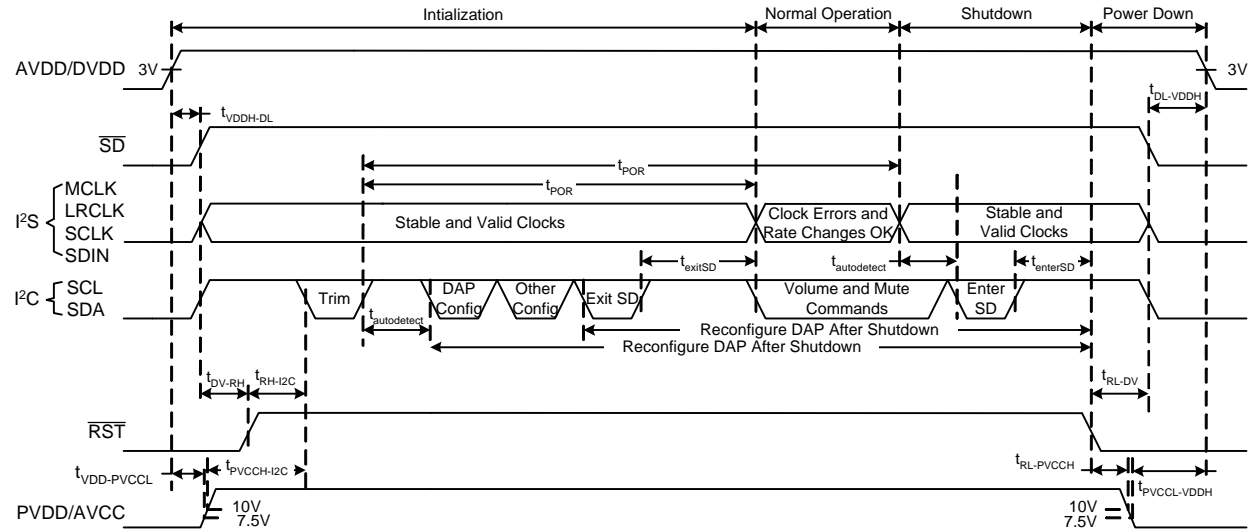


Figure 13. Recommended Command Sequence

Parameter	Description	APA3160A			Unit
		Min.	Typ.	Max.	
$t_{VDDH-DL}$	Time digital inputs must remain low after AVDD/DVDD goes above 3V	0	-	-	μ s
$t_{DL-VDDH}$	Time digital inputs must be low before AVDD/DVDD goes below 3V	0	-	-	
$t_{VDDH-PVDDL}$	Time PVDD/AVCC remains below 7.5V after AVDD/DVDD goes above 3V	100	-	-	
$t_{PVDDL-VDDH}$	Time PVDD/AVCC must be below 7.5V before AVDD/DVDD goes below 3V	0	-	-	
$t_{PVDDH-I2C}$	Time PVDD/AVCC must be above 10V before I ² C commands may address device	10	-	-	
$t_{RL-PVDDH}$	Time PVDD/AVCC must remain above 10V after \overline{RST} goes low	2	-	-	
t_{RH-I2C}	Time RESET must be high before I ² C commands may address device	13.5	-	-	ms
t_{DV-RH}	Time digital inputs must be valid (driven as recommended) before \overline{RST} goes high	100	-	-	μ s
t_{RL-DV}	Time digital inputs must remain valid (driven as recommended) after \overline{RST} goes low	2	-	-	
$t_{autodetect}$	Auto-detect completion wait time (given stable and valid clocks) before issuing further commands	50	-	-	ms
t_{exitSD}	Exit shutdown wait time before issuing further commands to device (t start given by register 0x1A)	$1+1.3 \times t_{start}$	-	-	
$t_{enterSD}$	Enter shutdown wait time before issuing further commands to device (t stop given by register 0x1A)	$1+1.3 \times t_{stop}$	-	-	
t_{POR}	Power-on-reset wait time after 1st trim following AVDD/DVDD power-up (t _{start} given by register 0x1A) (does not apply to trim commands following subsequent resets)	$240 + 1.3 \times t_{start}$	-	-	

Function Description (Cont.)

Recommended Use Model (Cont.)

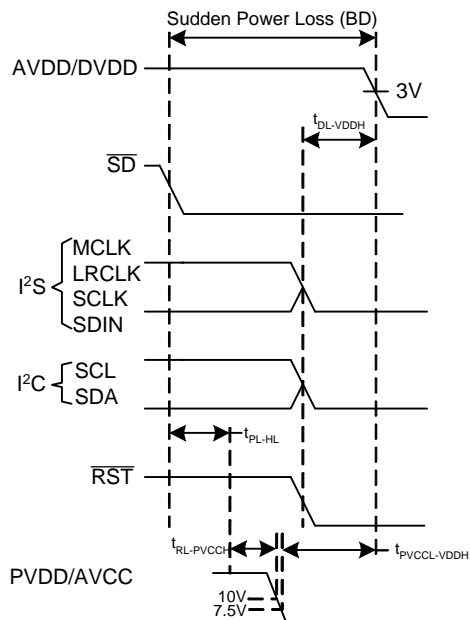


Figure 14. Power Loss Sequence

Parameter	Description	APA3160A			Unit
		Min.	Typ.	Max.	
t_{RL-DV}	Time digital inputs must remain valid (driven as recommended) after RST goes low	2	-	-	μs
$t_{DL-VDDH}$	Time digital inputs must be low before AVDD/DVDD goes below 3V	0	-	-	
$t_{RL-PVDDH}$	Time PVDD/AVCC must remain above 10V after RST goes low	2	-	-	
$t_{PVDDL-VDDH}$	Time PVDD/AVCC must be below 7.5V before AVDD/DVDD goes below 3V	0	-	-	

Recommended Command Sequences

The DAP has two groups of commands. One set is for configuration and is intended for use only during initialization. The other set has built-in click and pop protection and may be used during normal operation while audio is streaming. The following supported command sequences illustrate how to initialize, operate, and shutdown the device.

Function Description (Cont.)

Initialization Sequence

Use the following sequence to power-up and initialize the device:

1. Hold all digital inputs low and ramp up AVDD/DVDD to at least 3V.
2. Initialize digital inputs and PVDD supply as following:
 - Drive $\overline{RST}=0$, $\overline{SD}=1$, and other digital inputs to their desired state while ensuring that all are never more than 2.5V above AVDD/DVDD. Provide stable and valid I²S clocks (MCLK, LRCLK, and SCLK). Wait at least 100 μ s, drive $\overline{RST}=1$, and wait at least another 13.5ms.
 - Ramp up PVDD to at least 8V while ensuring that it remains below 6V for at least 100 μ s after AVDD/DVDD reaches 3V. Then wait at least another 10 μ s.
3. Configure the DAP via I²C (see Users's Guide for typical values): biquads (0x29-36)DRC parameters (0x3A-3C, 0x40-42, and 0x46) Bank select (0x50).
4. Configure remaining registers.
5. Exit shutdown (sequence defined below).

Normal Operation

The following are the only events supported during normal operation:

- (a) Writes to master/channel volume registers
- (b) Writes to soft mute register
- (c) Enter and exit shutdown (sequence defined below)
- (d) Clock errors and rate changes

Note: Events (c) and (d) are not supported for $240\text{ms}+1.3t_{0}$ after trim following AVDD/DVDD power up ramp (where Tstart is specified by register 0x1A).

Shutdown Sequence

Enter:

1. Ensure I²S clocks have been stable and valid for at least 50ms.
2. Write 0x40 to register 0x05.
3. Wait at least $1\text{ms}+1.3t_{\text{stop}}$ (where t_{stop} is specified by register 0x1A).
4. Once in shutdown, stable clocks are not required while device remains idle.
5. If desired, reconfigure by ensuring that clocks have been stable and valid for at least 50ms before returning to step 4 of initialization sequence.

Exit:

1. Ensure I²S clocks have been stable and valid for at least 50ms.
2. Write 0x00 to register 0x05 (exit shutdown command may not be serviced for as much as 240ms after trim following AVDD/DVDD powerup ramp).
3. Wait at least $1\text{ms}+1.3t_{\text{start}}$ (where t_{start} is specified by register 0x1A).
4. Proceed with normal operation.

Function Description (Cont.)

Power-down Sequence

Use the following sequence to power-down the device and its supplies:

1. If time permits, enter shutdown (sequence defined above); else, in case of sudden power loss, assert $\overline{SD}=0$ and wait at least 2ms.
2. Assert $\overline{RST}=0$.
3. Drive digital inputs low and ramp down PVDD supply as follows:
 - Drive all digital inputs low after \overline{RST} has been low for at least $2\mu s$.
 - Ramp down PVDD while ensuring that it remains above 8V until \overline{RST} has been low for at least $2\mu s$.
4. Ramp down AVDD/DVDD while ensuring that it remains above 3V until PVDD is below 6V and that it is never more than 2.5V below the digital inputs.

Table 1. Serial Control Interface Register Summary

Sub Address	Register Name	No. of Bytes	Contents	Initialization Values
			A u indicates unused bits.	
0x00	Clock control register	1	Description shown in subsequent section	0x6C
0x02	Error status register	1	Description shown in subsequent section	0x00
0x03	System control register 1	1	Description shown in subsequent section	0x80
0x04	Serial data interface	1	Description shown in subsequent section	0x05
0x05		1	Description shown in subsequent section	0x40
0x06	Soft mute register	1	Description shown in subsequent section	0x00
0x07	Master volume	1	Description shown in subsequent section	0xFF (mute)
0x08	Channel 1 vol	1	Description shown in subsequent section	0x30 (0dB)
0x09	Channel 2 vol	1	Description shown in subsequent section	0x30 (0dB)
0x0A	Fine master volume	1	Description shown in subsequent section	0x00 (0dB)
0x0B - 0x0D			Reserved ^(Note 4)	
0x0E	Volume configuration register	1	Description shown in subsequent section	0x91
0x0F		1	Reserved ^(Note 4)	
0x10	Modulation limit register	1	Description shown in subsequent section	0x02
0x15-0x19		1	Reserved ^(Note 4)	
0x1A	Start/stop period register	1	Description shown in subsequent section	0x0F
0x1B		1	Reserved ^(Note 4)	
0x1C		1	Reserved ^(Note 4)	
0x1D-0x1F		1	Reserved ^(Note 4)	
0x20	Input MUX register	1	Description shown in subsequent section	0x 89
0x21-0x24		1	Reserved ^(Note 4)	
0x25	PWM MUX register	1	Description shown in subsequent section	0x27
0x26-0xFF		1	Reserved ^(Note 4)	

Note 4: Reserved register should not be accessed.

Function Description (Cont.)

Clock Control Register (0x00)

The clocks and data rates are automatically determined by the APA3160A. The clock control register contains the auto-detected clock status. Bits D7-D5 reflect the sample rate. Bits D4-D2 reflect the MCLK frequency.

Table 2. Clock Control Register (0x00)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	-	-	-	-	-	$f_s=32\text{kHz}$ sample rate
0	0	1	-	-	-	-	-	$f_s=88.2/96\text{kHz}$ sample rate
0	1	0	-	-	-	-	-	$f_s=176.4/192\text{kHz}$ sample rate
0	1	1	-	-	-	-	-	$f_s=44.1/48\text{kHz}$ sample rate
1	0	0	-	-	-	-	-	Reserved ^(Note 5)
1	0	1	-	-	-	-	-	Reserved ^(Note 5)
1	1	0	-	-	-	-	-	Reserved ^(Note 5)
1	1	1	-	-	-	-	-	Reserved ^(Note 5)
-	-	-	0	0	0	-	-	MCLK frequency= $64f_s$
-	-	-	0	0	1	-	-	MCLK frequency= $128f_s$
-	-	-	0	1	0	-	-	MCLK frequency= $192f_s$ ^(Note 6)
-	-	-	0	1	1	-	-	MCLK frequency= $256f_s$ ^(Note 6)
-	-	-	1	0	0	-	-	MCLK frequency= $384f_s$ ^(Note 7)
-	-	-	1	0	1	-	-	MCLK frequency= $512f_s$ ^(Note 7)
-	-	-	1	1	0	-	-	Reserved ^(Note 5)
-	-	-	1	1	1	-	-	Reserved ^(Note 5)
-	-	-	-	-	-	0	-	Reserved ^(Note 5)
-	-	-	-	-	-	-	0	Reserved ^(Note 5)

Note (5): Reserved registers should not be accessed.

Note (6): Rate only available for 32k/44.1k/48k/88.2k/96kHz sample rates.

Note (7): Rate only available for 32k/44.1k/48k sample rates.

Function Description (Cont.)

Error Status Register (0x02)

The error bits are sticky and are not cleared by the hardware. This means that the software must clear the register (write zeroes) and then read them to determine if they are persistent errors. Error Definitions:

MCLK Error : MCLK frequency is changing. The number of MCLKs per LRCLK is changing.

SCLK Error: The number of SCLKs per LRCLK is changing.

LRCLK Error: LRCLK frequency is changing.

Table 4. Error Status Register (0x02)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
1	-	-	-	-	-	-	-	MCLK error
-	1	-	-	-	-	-	-	PLL auto clock error
-	-	1	-	-	-	-	-	SCLK error
-	-	-	1	-	-	-	-	LRCLK error
-	-	-	-	1	-	-	-	Reserved
-	-	-	-	-	1	-	-	Reserved
-	-	-	-	-	-	0	-	Over-Current (OC) or Under-Voltage (UVP) or Over-Temperature (OTP) warning
-	-	-	-	-	-	-	1	Over-temperature warning (sets around 145°C) POR error, OCP, thermal shutdown error
0	0	0	0	0	0	0	0	No errors

System Control Register 1 (0x03)

The system control register 1 has several functions:

Bit D7: If 0, the dc-blocking filter for each channel is disabled. If 1, the dc-blocking filter (-3dB cutoff < 1Hz) for each channel is enabled (default).

Bit D5: If 0, use soft unmute on recovery from clock error. This is a slow recovery. Unmute takes same time as volume ramp defined in reg 0x0E. If 1, use hard unmute on recovery from clock error (default). This is a fast recovery, a single step volume ramp

Bits D1-D0: Select de-emphasis.

Table 5. System Control Register 1 (0x03)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	-	-	-	-	PWM high-pass (dc blocking) disenabled
1	-	-	-	-	-	-	-	PWM high-pass (dc blocking) enabled
-	0	-	-	-	-	-	-	Reserved
-	-	0	-	-	-	-	-	Reserved
-	-	-	0	-	-	-	-	Reserved
-	-	-	-	0	-	-	-	Reserved
-	-	-	-	-	0	-	-	Reserved
-	-	-	-	-	-	0	0	No de-emphasis
-	-	-	-	-	-	0	1	Reserved
-	-	-	-	-	-	1	0	De-emphasis for $f_s=44.1\text{kHz}$
-	-	-	-	-	-	1	1	De-emphasis for $f_s=48\text{kHz}$

Function Description (Cont.)

Serial Data Interface Register (0x04)

As shown in Table 6, the APA3160A supports 9 serial data modes. The default is 24bit, I²S mode.

Table 6. Serial Data Interface Control Register (0x04) Format

D7	D6	D5	D4	D3	D2	D1	D0	Word Length	Receive Serial Data Interface Format
0	0	0	0	0	0	0	0	16	Right-justified
0	0	0	0	0	0	0	1	20	Right-justified
0	0	0	0	0	0	1	0	24	Right-justified
0	0	0	0	0	0	1	1	16	I ² S
0	0	0	0	0	1	0	0	20	I ² S
0	0	0	0	0	1	0	1	24	I ² S
0	0	0	0	0	1	1	0	16	Left-justified
0	0	0	0	0	1	1	1	20	Left-justified
0	0	0	0	1	0	0	0	24	Left-justified

System Control Register 2 (0x05)

When bit D6 is set low, the system exits all channel shutdown and starts playing audio; otherwise, the outputs are shut down (hard mute).

Table 7. System Control Register 2 (0x05)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	-	-	-	-	Reserved
-	1	-	-	-	-	-	-	Enter all channel shut down (hard mute)
-	0	-	-	-	-	-	-	Exit all channel shut down (Normal operation)
-	-	0	0	0	0	0	0	Reserved

Soft Mute Register (0x06)

Writing a 1 to any of the following bits sets the output of the respective channel to 50% duty cycle (soft mute).

Table 8. Soft Mute Register (0x06)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	-	-	-	-	1	Soft mute channel 1
-	-	-	-	-	-	-	0	Soft un-mute channel 1
-	-	-	-	-	-	1	-	Soft mute channel 2
-	-	-	-	-	-	0	-	Soft un-mute channel 2
0	0	0	0	0	0	-	-	Reserved

Function Description (Cont.)

Volume Registers (0x07, 0x08, 0x09)

Step size is 0.5 dB.

Master volume - 0x07 (default is mute)

Channel-1 volume - 0x08 (default is 0 dB)

Channel-2 volume - 0x09 (default is 0 dB)

Table 9. Volume Registers (0x07, 0x08, 0x09)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	0	0	0	0	0	24dB
0	0	1	1	0	0	0	0	0dB
1	1	0	0	1	1	0	1	-78.5dB
1	1	0	0	1	1	1	0	-79.0dB
1	1	0	0	1	1	1	1	Values between 0xCF and 0xFE are Reserved
1	1	1	1	1	1	1	0	Bypass Volume Control(only for Register 0x07)
1	1	1	1	1	1	1	1	MUTE (default for master volume)

Master Fine Volume Register (0x0A)

This register can be used to provide precision tuning of master volume.

Table 10. Master Fine Volume Register (0x0A)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	-	-	-	0	0	0dB
-	-	-	-	-	-	0	1	0.125dB
-	-	-	-	-	-	1	0	0.25dB
-	-	-	-	-	-	1	1	0.375dB
0	0	0	0	0	0	-	-	Reserved

Volume Configuration Register (0x0E)

Bits Volume slew rate (Used to control volume change and MUTE ramp rates). These bits control the D2-D0: number of steps in a volume ramp. Volume steps occur at a rate that depends on the sample rate of the I²S data.

Table 11. Volume Control Register (0x0E)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
1	0	0	1	0	-	-	-	Reserved
-	-	-	-	-	0	0	0	Volume slew 512 steps
-	-	-	-	-	0	0	1	Volume slew 1024 steps
-	-	-	-	-	0	1	0	Volume slew 2048 steps
-	-	-	-	-	0	1	1	Volume slew 256 steps
-	-	-	-	-	1	0	0	Reserved

Function Description (Cont.)

Volume Configuration Register (0x0E) (Cont.)

Table 11. Volume Control Register (0x0E)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	-	-	1	0	1	Reserved
-	-	-	-	-	1	1	0	Reserved
-	-	-	-	-	1	1	1	Volume slew 0 step

Modulation Limit Register (0x10)

Table 12. Modulation Limit Register (0x10)

D7	D6	D5	D4	D3	D2	D1	D0	MODULATION LIMIT
-	-	-	-	-	0	0	0	Reserved
-	-	-	-	-	0	0	1	98.4%
-	-	-	-	-	0	1	0	97.7%
-	-	-	-	-	0	1	1	96.9%
-	-	-	-	-	1	0	0	96.1%
-	-	-	-	-	1	0	1	95.3%
-	-	-	-	-	1	1	0	94.5%
-	-	-	-	-	1	1	1	93.8%
0	0	0	0	0	-	-	-	Reserved

Start/Stop Period Register (0x1A)

This register is used to control the soft-start and soft-stop period following an enter/exit all channel shut down command or change in the SD state. This helps to reduce pops and clicks at start-up and shutdown. The times are only approximate and vary depending on device activity level and I²S clock stability.

Table 13. Start/Stop Period Register (0x1A)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	0	-	-	-	-	-	Reserved
-	-	-	0	0	-	-	-	Reserved
-	-	-	0	1	0	0	0	16.5ms 50% duty cycle start/stop period
-	-	-	0	1	0	0	1	23.9ms 50% duty cycle start/stop period
-	-	-	0	1	0	1	0	31.4ms 50% duty cycle start/stop period
-	-	-	0	1	0	1	1	40.4ms 50% duty cycle start/stop period
-	-	-	0	1	1	0	0	53.9ms 50% duty cycle start/stop period
-	-	-	0	1	1	0	1	70.3ms 50% duty cycle start/stop period
-	-	-	0	1	1	1	0	94.2ms 50% duty cycle start/stop period
-	-	-	0	1	1	1	1	125.7ms 50% duty cycle start/stop period

Function Description (Cont.)

Start/Stop Period Register (0x1A) (Cont.)

Table 13. Start/Stop Period Register (0x1A)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	1	0	0	0	0	164.6ms 50% duty cycle start/stop period
-	-	-	1	0	0	0	1	239.4ms 50% duty cycle start/stop period
-	-	-	1	0	0	1	0	314.2ms 50% duty cycle start/stop period
-	-	-	1	0	0	1	1	403.9ms 50% duty cycle start/stop period
-	-	-	1	0	1	0	0	538.6ms 50% duty cycle start/stop period
-	-	-	1	0	1	0	1	703.4ms 50% duty cycle start/stop period
-	-	-	1	0	1	1	0	942.5ms 50% duty cycle start/stop period
-	-	-	1	0	1	1	1	1256.6ms 50% duty cycle start/stop period
-	-	-	1	1	0	0	0	1728.1ms 50% duty cycle start/stop period
-	-	-	1	1	0	0	1	2513.6ms 50% duty cycle start/stop period
-	-	-	1	1	0	1	0	3299.1ms 50% duty cycle start/stop period
-	-	-	1	1	0	1	1	4241.7ms 50% duty cycle start/stop period
-	-	-	1	1	1	0	0	5655.6ms 50% duty cycle start/stop period
-	-	-	1	1	1	0	1	7383.7ms 50% duty cycle start/stop period
-	-	-	1	1	1	1	0	9897.3ms 50% duty cycle start/stop period
-	-	-	1	1	1	1	0	13196.4ms 50% duty cycle start/stop period

Input Multiplexer Register (0x20)

This register controls the modulation scheme (BD mode) as well as the routing of I²S audio to the internal channels.

Table 14. Input Multiplexer Register (0x20)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	-	-	-	-	-	-	-	Reserved
1	-	-	-	-	-	-	-	Channel 1 BD mode
-	0	0	0	-	-	-	-	SDIN-L to Channel 1
-	0	0	1	-	-	-	-	SDIN-R to Channel 1
-	0	1	0	-	-	-	-	Reserved
-	0	1	1	-	-	-	-	Reserved
-	1	0	0	-	-	-	-	Reserved
-	1	0	1	-	-	-	-	Reserved
-	1	1	0	-	-	-	-	Ground (0) to channel 1
-	1	1	1	-	-	-	-	Reserved
-	-	-	-	0	-	-	-	Reserved
-	-	-	-	1	-	-	-	Channel-2 BD mode
-	-	-	-	-	0	0	0	SDIN-L to Channel 2
-	-	-	-	-	0	0	1	SDIN-R to Channel 2

Function Description (Cont.)

Input Multiplexer Register (0x20) (Cont.)

Table 14. Input Multiplexer Register (0x20)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	-	-	0	1	0	Reserved
-	-	-	-	-	0	1	1	Reserved
-	-	-	-	-	1	0	0	Reserved
-	-	-	-	-	1	0	1	Reserved
-	-	-	-	-	1	1	0	Ground (0) to channel 2
-	-	-	-	-	1	1	1	Reserved

Pwm Output Mux Register (0x25)

This DAP output mux selects which internal PWM channel is output to the external pins. Any channel can be output to any external output pin.

Bits D7-D6: Selects which PWM channel is output to OUT_A

Bits D5-D4: Selects which PWM channel is output to OUT_B

Bits D3-D2: Selects which PWM channel is output to OUT_C

Bits D1-D0: Selects which PWM channel is output to OUT_D

Note that channels are enclosed so that channel 1=0x00, channel 2=0x01, channel 1=0x02, and channel 2=0x03.

Table 15. PWM Output Mux Register (0x25)

D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
0	0	-	-	-	-	-	-	Multiplex channel 1 to OUT_A
0	1	-	-	-	-	-	-	Multiplex channel 2 to OUT_A
1	0	-	-	-	-	-	-	Multiplex channel 1 to OUT_A
1	1	-	-	-	-	-	-	Multiplex channel 2 to OUT_A
-	-	0	0	-	-	-	-	Multiplex channel 1 to OUT_B
-	-	0	1	-	-	-	-	Multiplex channel 2 to OUT_B
-	-	1	0	-	-	-	-	Multiplex channel 1 to OUT_B
-	-	1	1	-	-	-	-	Multiplex channel 2 to OUT_B
D7	D6	D5	D4	D3	D2	D1	D0	FUNCTION
-	-	-	-	0	0	-	-	Multiplex channel 1 to OUT_C
-	-	-	-	0	1	-	-	Multiplex channel 2 to OUT_C
-	-	-	-	1	0	-	-	Multiplex channel 1 to OUT_C
-	-	-	-	1	1	-	-	Multiplex channel 2 to OUT_C
-	-	-	-	-	-	0	0	Multiplex channel 1 to OUT_D
-	-	-	-	-	-	0	1	Multiplex channel 2 to OUT_D
-	-	-	-	-	-	1	0	Multiplex channel 1 to OUT_D
-	-	-	-	-	-	1	1	Multiplex channel 2 to OUT_D

Function Description (Cont.)

Over-Current (OC) Protection With Current-Limiting

The device has independent, fast-reacting current detectors on all high-side and low-side power-stage FETs. The detector outputs are closely monitored by two protection systems. The first protection system controls the power stage in order to prevent the output current further increasing, i.e., it performs a cycle-by-cycle current-limiting function, rather than prematurely shutting down during combinations of high-level music transients and extreme speaker load impedance drops. If the high-current condition situation persists, i.e., the power stage is being overloaded, a second protection system triggers a latching shutdown, resulting in the power stage being set in the high-impedance (Hi-Z) state. The device returns to normal operation once the fault condition (i.e., a short-circuit on the output) is removed. Current-limiting and overcurrent protection are not independent for half-bridges.

That is, if the bridge-tied load between half-bridges A and B causes an overcurrent fault, half-bridges A, B, C, and D are shut down.

Over-Temperature Protection

The APA3160A has over-temperature protection system. If the device junction temperature exceeds 150°C (nominal), the device is put into thermal shutdown, resulting in all half-bridge outputs being set in the high-impedance (Hi-Z) state and FAULT being asserted low. The APA3160A recovers automatically once the temperature drops approximately 30°.

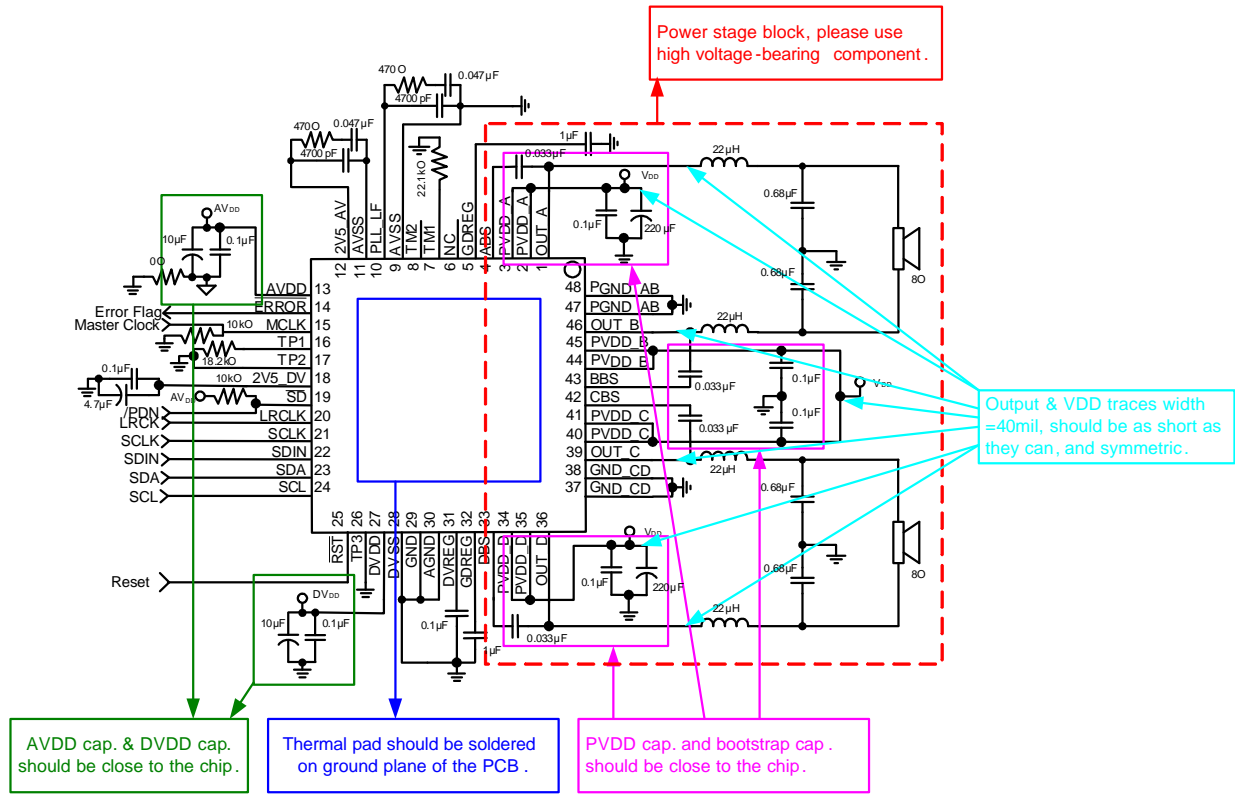
Under-Voltage Protection (UVP) and Power-On-Reset (POR)

The UVP and POR circuits of the APA3160A fully protect the device in any power-up/down and brownout situation.

While powering up, the POR circuit resets the overload circuit (OLP) and ensures that all circuits are fully operational when the PVDD and AVDD supply voltages reach 7.6V and 2.7V, respectively. Although PVDD and AVDD are independently monitored, a supply voltage drop below the UVP threshold on AVDD or either PVDD pin results in all half-bridge outputs immediately being set in the high-impedance (Hi-Z) state and ERROR being asserted low.

Application Information

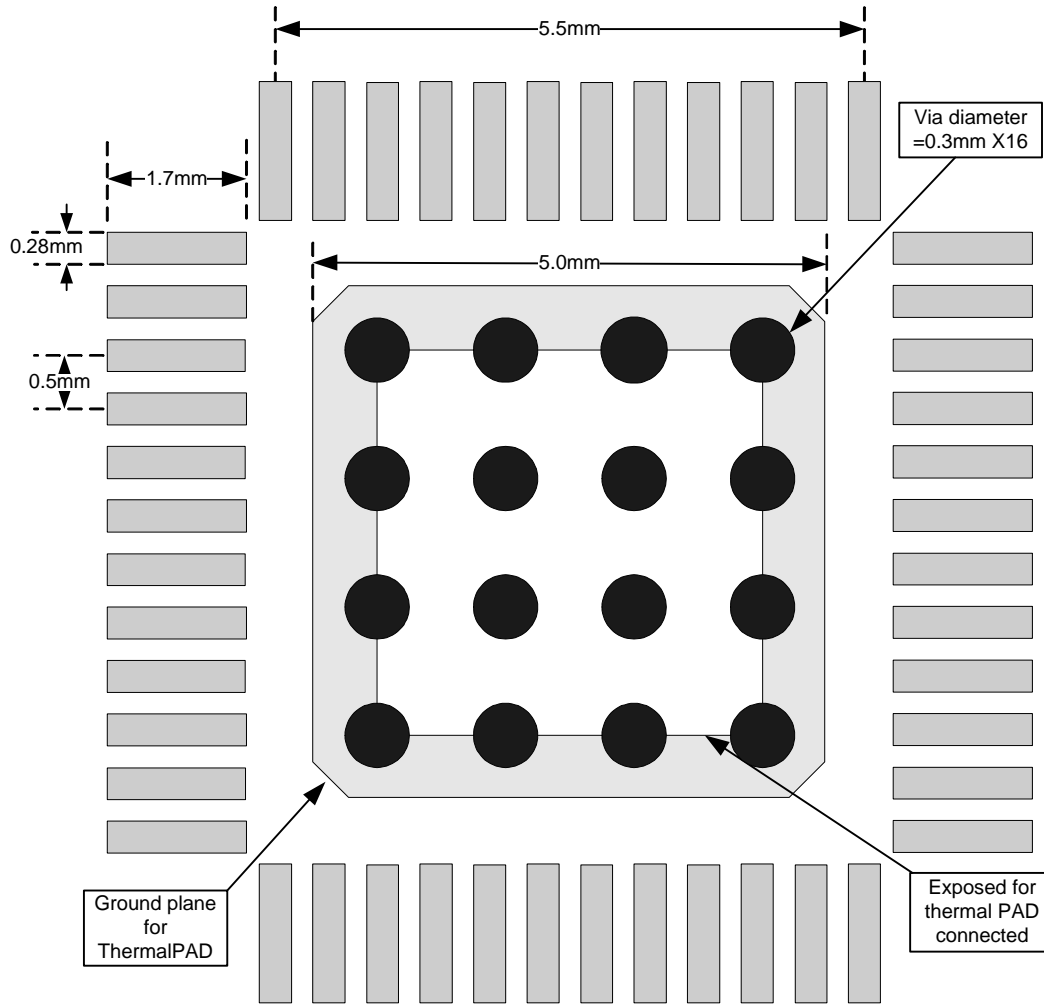
Layout Recommendation



Layout Recommendation

Application Information

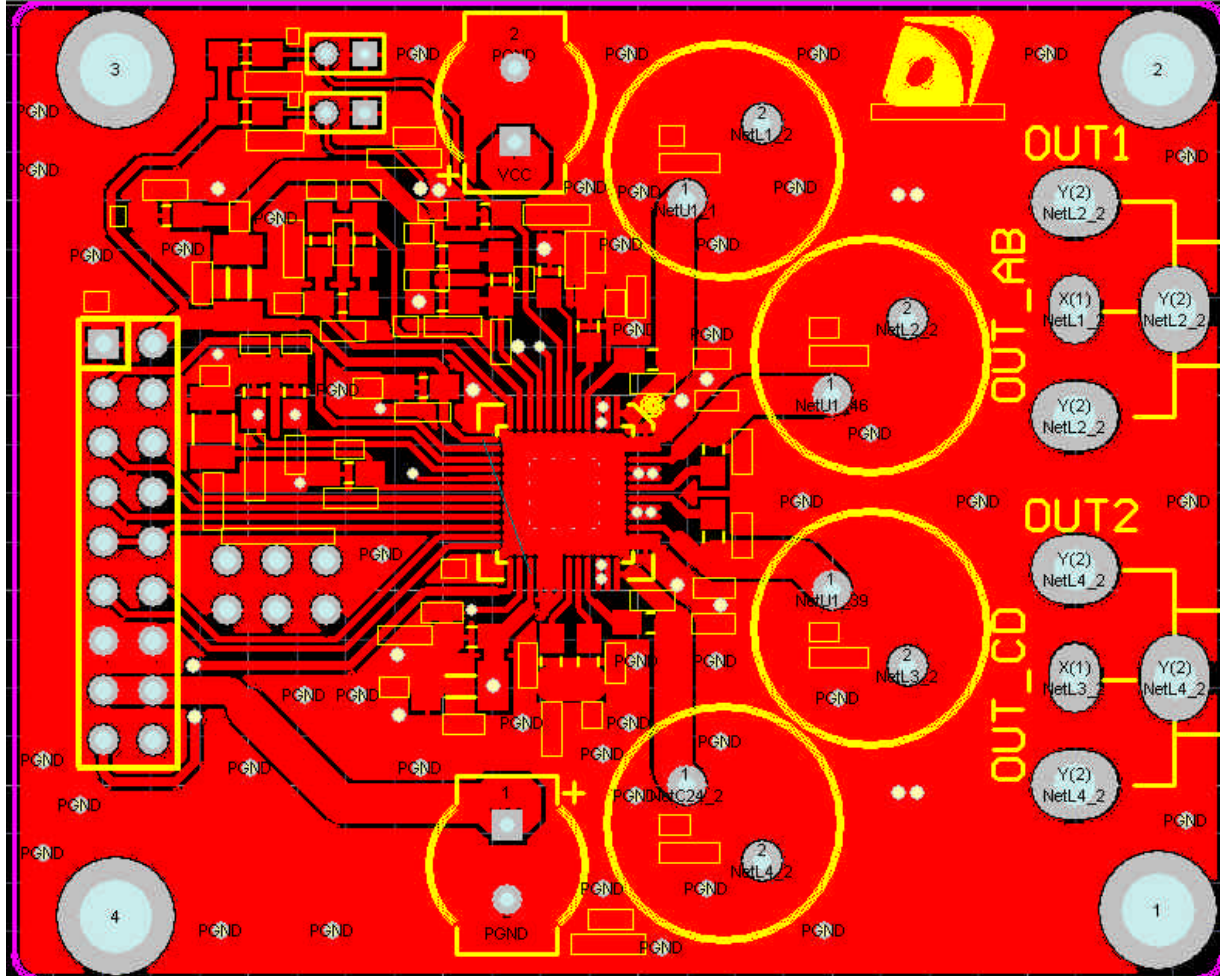
Layout Recommendation



TQFP7X7-48 Land Pattern Recommendation

Application Information

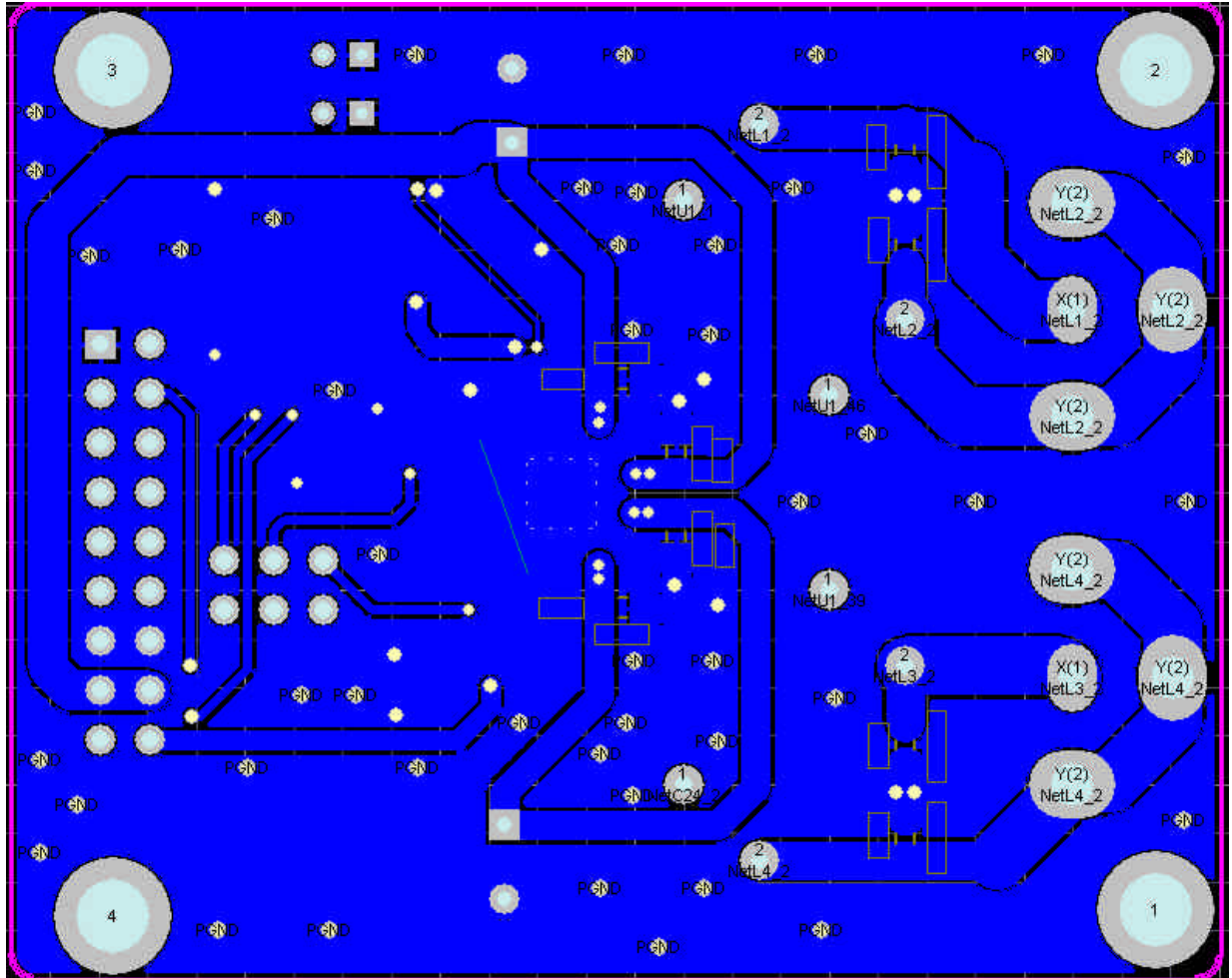
Layout Recommendation



PCB Reference (Top Layer)

Application Information

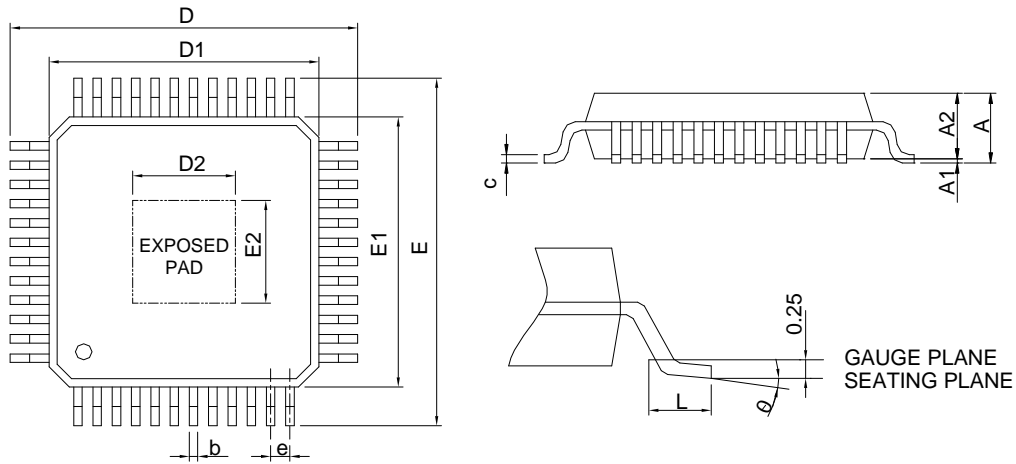
Layout Recommendation



PCB Reference (Bottom Layer)

Package Information

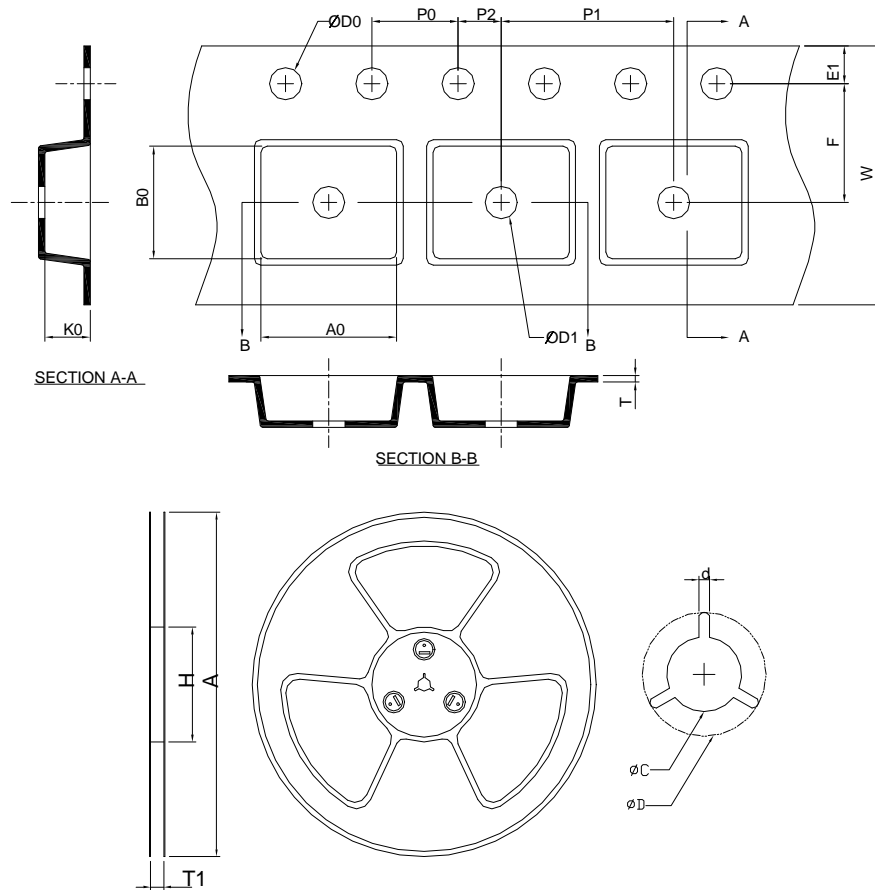
TQFP7x7-48P



SYMBOL	TQFP7x7-48P			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.20		0.047
A1	0.05	0.15	0.002	0.006
A2	0.95	1.05	0.037	0.041
b	0.17	0.27	0.007	0.011
c	0.09	0.20	0.004	0.008
D	8.80	9.20	0.346	0.362
D1	6.90	7.10	0.272	0.280
D2	3.00	5.50	0.118	0.177
E	8.80	9.20	0.346	0.362
E1	6.90	7.10	0.272	0.280
E2	3.00	5.50	0.118	0.177
e	0.50 BSC		0.020 BSC	
L	0.45	0.75	0.018	0.030
	0°	7°	0°	7°

Note : 1. Followed from JEDEC MS-026 ABC.
 2. Dimension "D1" and "E1" do not include mold protrusions.
 Allowable protrusions is 0.25 mm per side. "D1" and "E1" are maximum plasticbody size dimensions including mold mismatch.

Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
TQFP7x7-48P	330.0 ±2.00	50 MIN.	16.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	16.0 ±0.30	1.75 ±0.10	7.5 ±0.10
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0 ±0.10	12.0 ±0.10	2.0 ±0.10	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	9.4 ±0.20	9.4 ±0.20	1.8 ±0.20

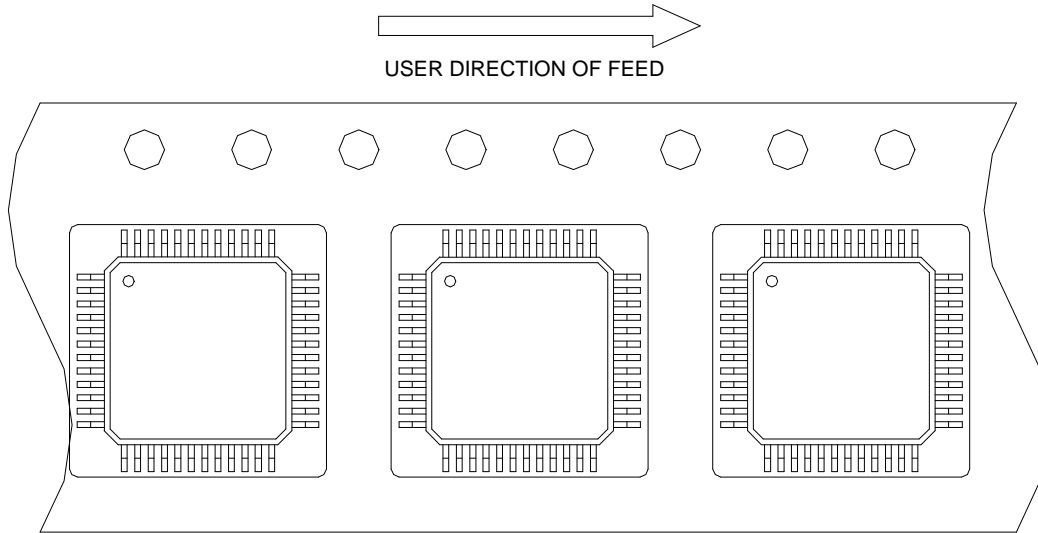
(mm)

Devices Per Unit

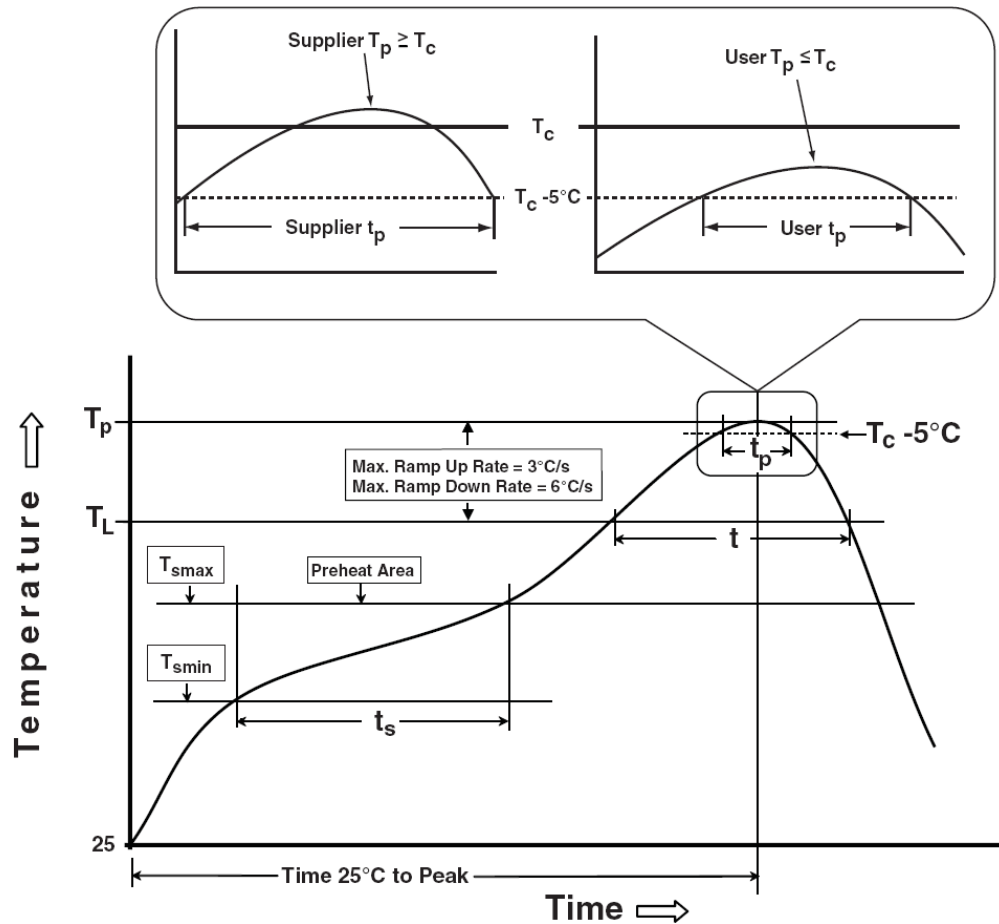
Package Type	Unit	Quantity
TQFP7x7-48P	Tape & Reel	2500

Taping Direction Information

TQFP7x7-48P



Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max.	3 °C/second max.
Liquidous temperature (T_L) Time at liquidous (t_L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_p)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	1000 Hrs, Bias @ $T_j=125^\circ\text{C}$
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C
HBM	MIL-STD-883-3015.7	VHBM 2KV
MM	JESD-22, A115	VMM 200V
Latch-Up	JESD 78	10ms, 1 _{tr} 100mA

Customer Service

Anpec Electronics Corp.

Head Office :

No.6, Dusing 1st Road, SBIP,
Hsin-Chu, Taiwan
Tel : 886-3-5642000
Fax : 886-3-5642050

Taipei Branch :

2F, No. 11, Lane 218, Sec 2 Jhongsing Rd.,
Sindian City, Taipei County 23146, Taiwan
Tel : 886-2-2910-3838
Fax : 886-2-2917-3838